

### General Features

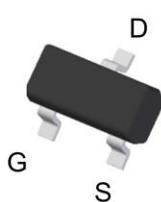
$V_{(BR)DSS}$	$R_{DS(on)}\text{MAX}$	$I_D$
60V	105mΩ@10V	3A
	125mΩ@4.5V	

### Application

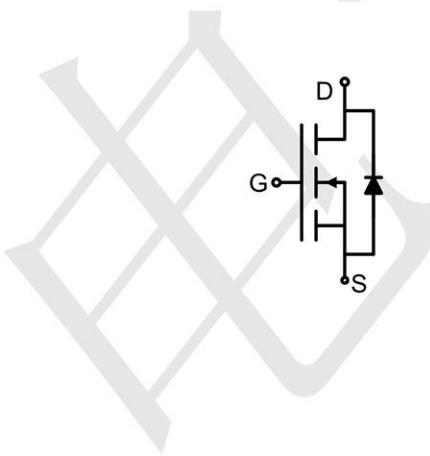
Load/Power Switching  
Interfacing Switching  
Battery Management for Ultra Small Portable  
Logic Level Shift

### Package and Pin Configuration

SOT23



### Circuit diagram



### Marking:

Or



### Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	60	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current	$I_D$	3	A
Pulsed Drain Current (note 1)	$I_{DM}$	10	A
Power Dissipation	$P_D$	0.35	W
Thermal Resistance from Junction to Ambient (note 2)	$R_{\theta JA}$	357	°C/W
Junction Temperature	$T_J$	150	°C
Storage Temperature	$T_{STG}$	-55~+150	°C

**Electrical Characteristics ( $T_A=25^\circ\text{C}$  unless otherwise noted)**

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>STATIC CHARACTERISTICS</b>						
Drain-source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	60			V
Zero gate voltage drain current	$I_{\text{DSS}}$	$V_{\text{DS}} = 60\text{V}, V_{\text{GS}} = 0\text{V}$			1	$\mu\text{A}$
Gate-body leakage current	$I_{\text{GSS}}$	$V_{\text{GS}} = \pm 20\text{V}, V_{\text{DS}} = 0\text{V}$			$\pm 100$	nA
Gate threshold voltage (note 3)	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	0.5		2	V
Drain-source on-resistance (note 3)	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, I_D = 3\text{A}$			105	$\text{m}\Omega$
		$V_{\text{GS}} = 4.5\text{V}, I_D = 3\text{A}$			125	$\text{m}\Omega$
Forward transconductance (note 3)	$g_{\text{FS}}$	$V_{\text{DS}} = 15\text{V}, I_D = 2\text{A}$	1.4			S
Diode forward voltage (note 3)	$V_{\text{SD}}$	$I_S = 3\text{A}, V_{\text{GS}} = 0\text{V}$			1.2	V
<b>DYNAMIC CHARACTERISTICS (note 4)</b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}} = 30\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		247		pF
Output Capacitance	$C_{\text{oss}}$			34		pF
Reverse Transfer Capacitance	$C_{\text{rss}}$			19.5		pF
<b>SWITCHING CHARACTERISTICS (note 4)</b>						
Turn-on delay time	$t_{\text{d}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, V_{\text{DD}} = 30\text{V}, I_D = 1.5\text{A}, R_{\text{GEN}} = 1\Omega$		6		ns
Turn-on rise time	$t_r$			15		ns
Turn-off delay time	$t_{\text{d}(\text{off})}$			15		ns
Turn-off fall time	$t_f$			10		ns
Total Gate Charge	$Q_g$	$V_{\text{DS}} = 30\text{V}, V_{\text{GS}} = 4.5\text{V}, I_D = 3\text{A}$		6		nC
Gate-Source Charge	$Q_{\text{gs}}$			1		nC
Gate-Drain Charge	$Q_{\text{gd}}$			1.3		nC

Typical Electrical and Thermal Characteristics (Curves)

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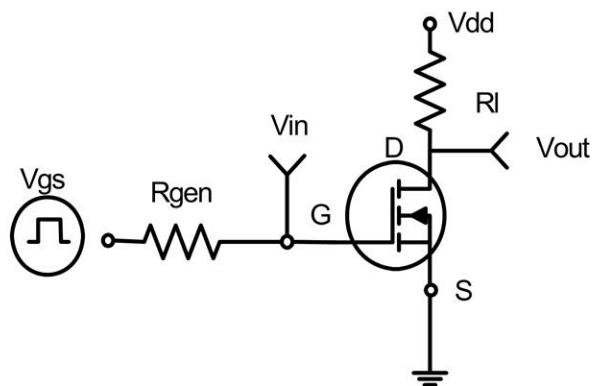


Figure 1:Switching Test Circuit

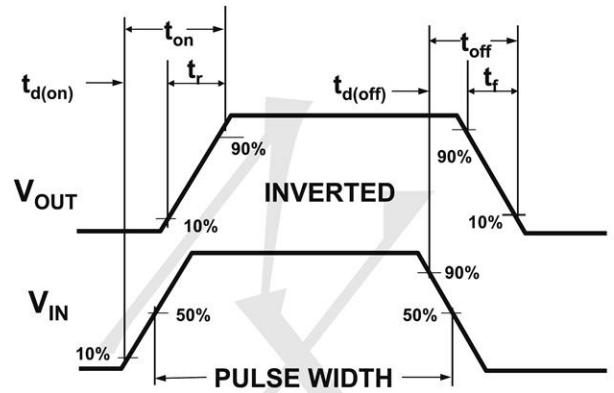
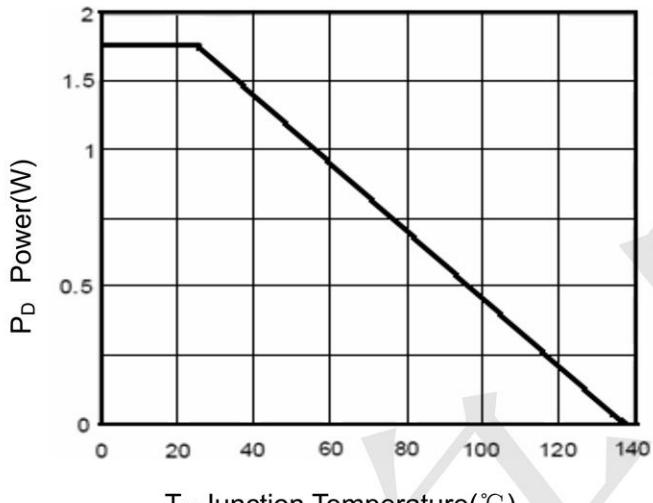
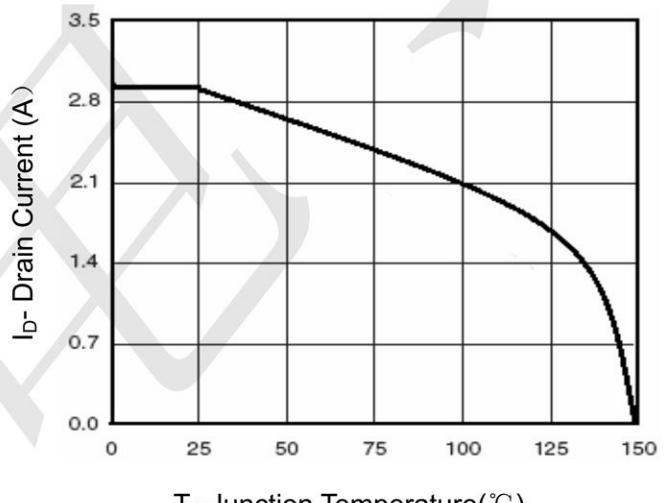


Figure 2:Switching Waveforms



T<sub>J</sub>-Junction Temperature(°C)

Figure 3 Power Dissipation



T<sub>J</sub>-Junction Temperature(°C)

Figure 4 Drain Current

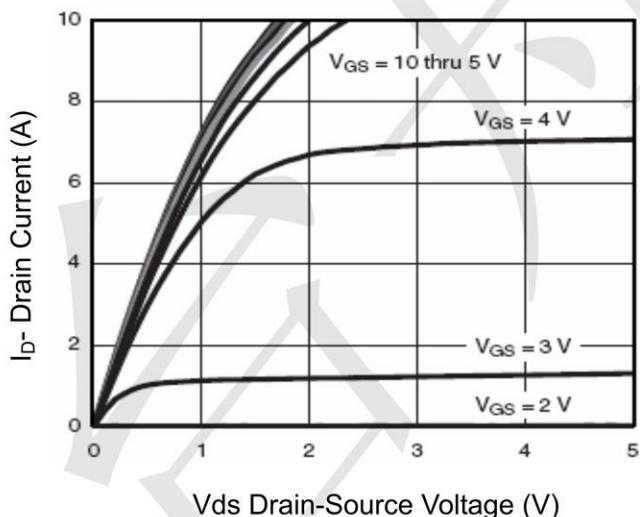


Figure 5 Output Characteristics

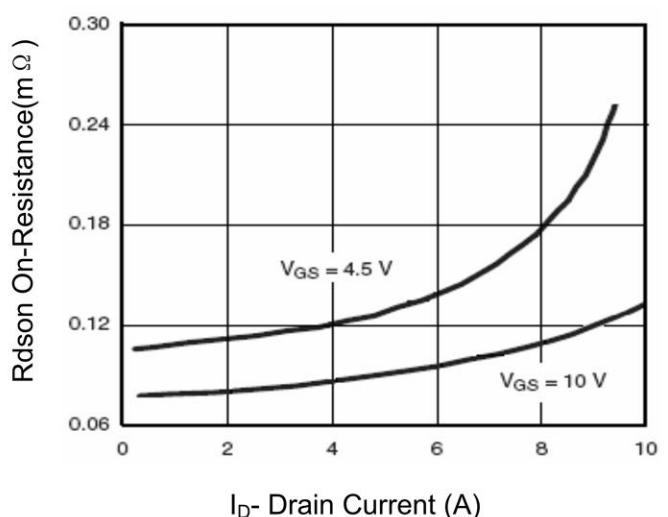


Figure 6 Drain-Source On-Resistance

Typical Electrical and Thermal Characteristics (Curves)

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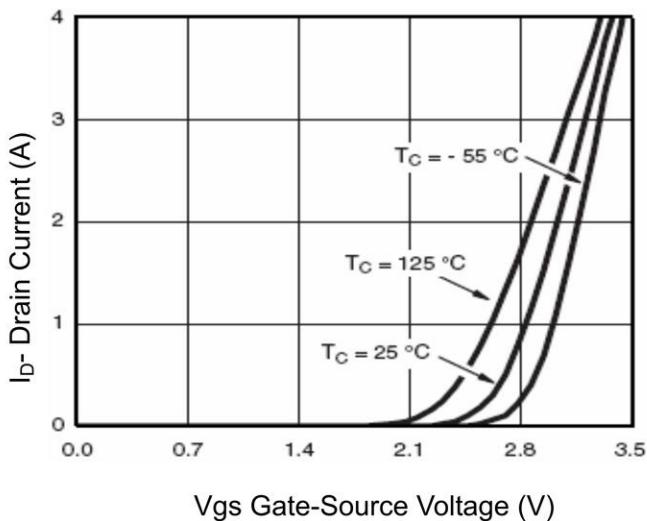


Figure 7 Transfer Characteristics

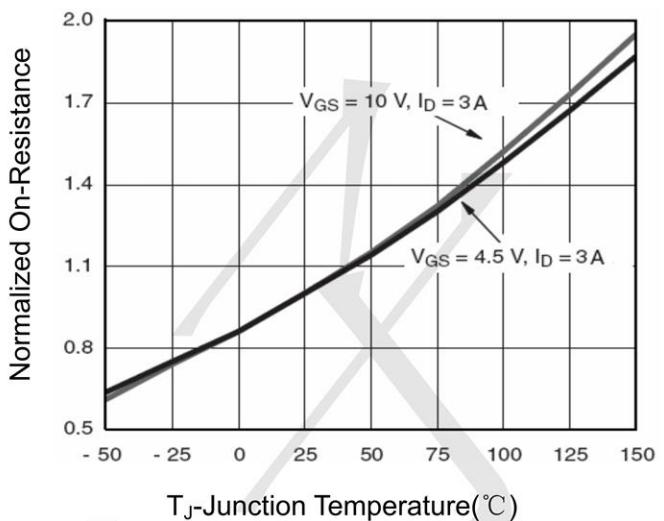


Figure 8 Drain-Source On-Resistance

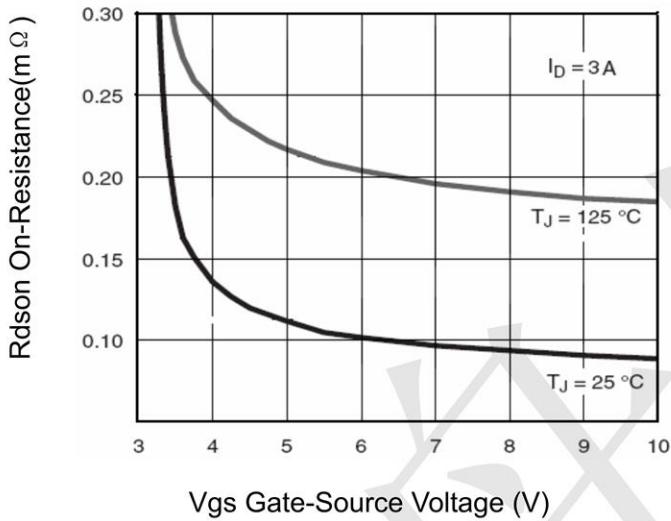


Figure 9  $R_{DS(on)}$  vs  $V_{GS}$

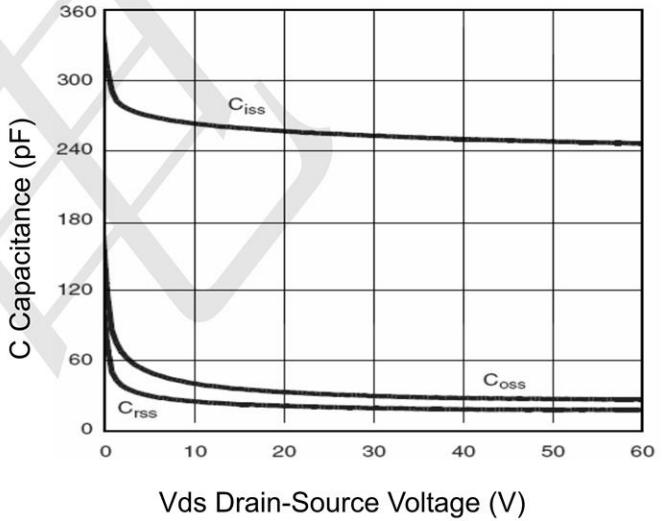


Figure 10 Capacitance vs  $V_{DS}$

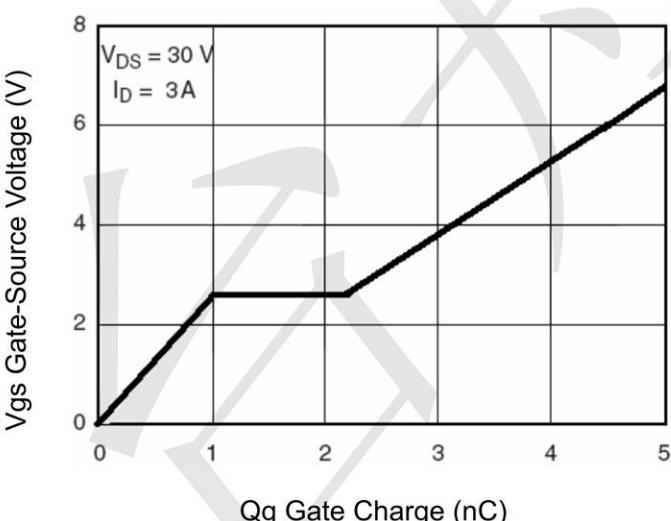


Figure 11 Gate Charge

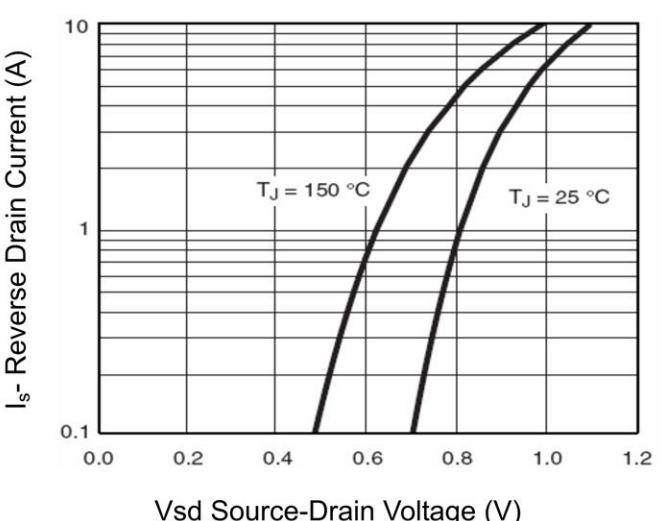
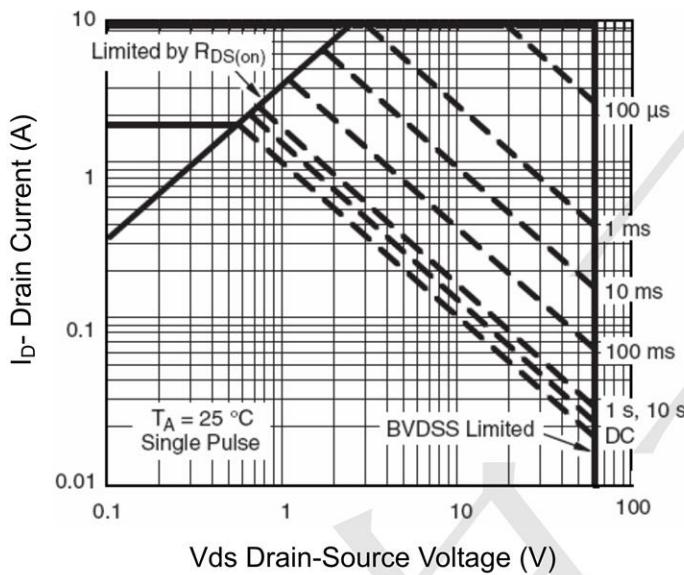
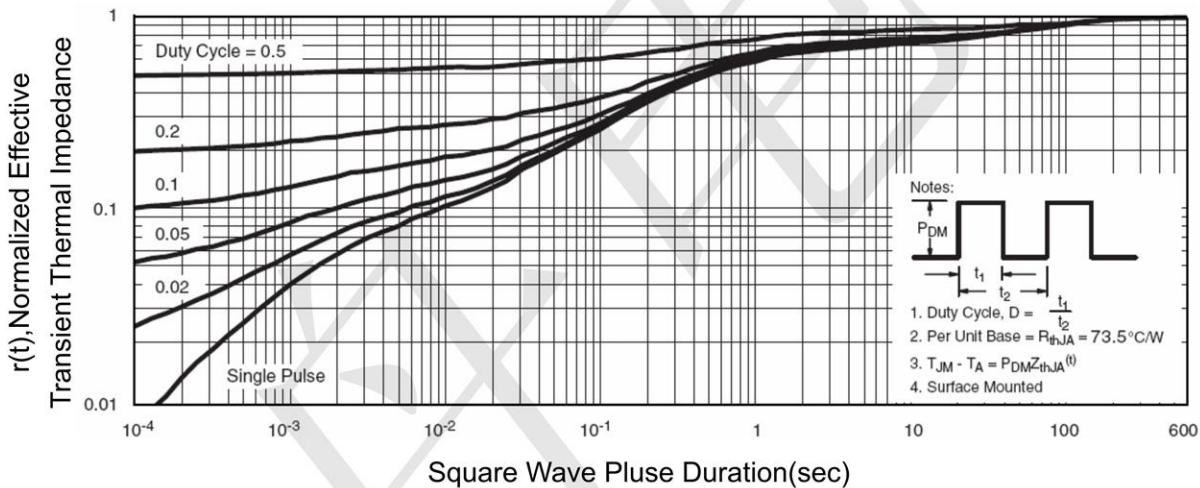


Figure 12 Source-Drain Diode Forward



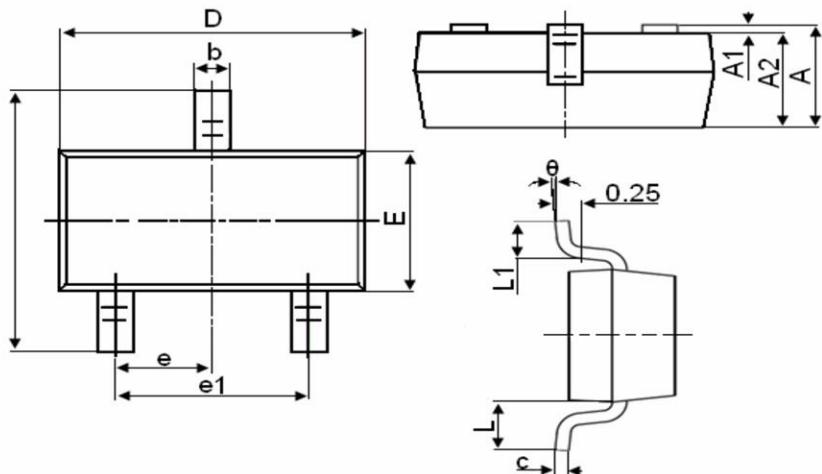
**Figure 13 Safe Operation Area**



**Figure 14 Normalized Maximum Transient Thermal Impedance**

### Package Outline Dimensions (SOT-23)

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Symbol	Dimensions in Millimeters	
	MIN.	MAX.
A	0.900	1.150
A1	0.000	0.100
A2	0.900	1.050
b	0.300	0.500
c	0.080	0.150
D	2.800	3.000
E	1.200	1.400
E1	2.250	2.550
e	0.950TYP	
e1	1.800	2.000
L	0.550REF	
L1	0.300	0.500
θ	0°	8°